Electronic Patent Application Fee Transmittal								
Application Number:	10518437							
Filing Date:	19-Sep-2005							
Title of Invention:	Foam forming die and method of manufacturing foam-formed article using the die							
First Named Inventor/Applicant Name:	Mikio Fukumura							
Filer:	Eric M. Nelson/Jennifer Yi							
Attorney Docket Number:	SAEG120.002APC							
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Description	Description		Quantity	Amount	Sub-Total in USD(\$)			
Basic Filing:								
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Petition:								
Patent-Appeals-and-Interference:								
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Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Miscellaneous:				
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